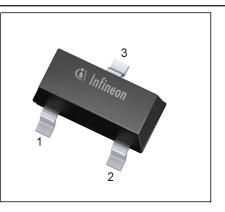


BFR93A

#### Low Noise Silicon Bipolar RF Transistor

- For low-noise, high gain broadband amplifiers at collector currents from 2 mA to 30 mA
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFR93A	R2s	1=B	2=E	3=C	SOT23

#### **Maximum Ratings** at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V <sub>CEO</sub>	12	V	
Collector-emitter voltage	V <sub>CES</sub>	20		
Collector-base voltage	V <sub>CBO</sub>	20		
Emitter-base voltage	V <sub>EBO</sub>	2		
Collector current	I <sub>C</sub>	90	mA	
Base current	I <sub>B</sub>	9		
Total power dissipation <sup>1)</sup>	P <sub>tot</sub>	300	mW	
<i>T</i> <sub>S</sub> ≤ 111 °C				
Junction temperature	T <sub>J</sub>	150	°C	
Storage temperature	T <sub>Stg</sub>	-55 150		

### Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>2)</sup>	R <sub>thJS</sub>	130	K/W

 $^{1}\mathcal{T}_{S}$  is measured on the collector lead at the soldering point to the pcb

<sup>2</sup>For the definition of  $R_{\text{thJS}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol		Values		Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	12	-	-	V
<i>I</i> <sub>C</sub> = 1 mA, <i>I</i> <sub>B</sub> = 0					
Collector-emitter cutoff current	I <sub>CES</sub>	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	10	μA
$V_{\rm EB}$ = 2.5 V, $I_{\rm C}$ = 0					
DC current gain	h <sub>FE</sub>	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

## **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified



Parameter	Symbol	Values		Unit	
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	I			
Transition frequency	f <sub>T</sub>	4.5	6	-	GHz
<i>I</i> <sub>C</sub> = 30 mA, <i>V</i> <sub>CE</sub> = 8 V, <i>f</i> = 500 MHz					
Collector-base capacitance	C <sub>cb</sub>	-	0.54	0.8	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
emitter grounded					
Collector emitter capacitance	C <sub>ce</sub>	-	0.25	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
base grounded					
Emitter-base capacitance	C <sub>eb</sub>	-	1.9	-	
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,					
collector grounded					
Minimum noise figure	NF <sub>min</sub>				dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,					
<i>f</i> = 900 MHz		-	1.5	-	
<i>f</i> = 1.8 GHz		-	2.6	-	
Power gain, maximum available <sup>1)</sup>	G <sub>ma</sub>				
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,					
<i>f</i> = 900 MHz		-	14.5	-	
<i>f</i> = 1.8 GHz		-	9.5	-	
Transducer gain	S <sub>21e</sub>   <sup>2</sup>				dB
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω,					
<i>f</i> = 900 MHz		-	12.5	-	
<i>f</i> = 1.8 MHz		-	7	-	
Third order intercept point at output <sup>2)</sup>	IP <sub>3</sub>	-	15	-	dBm
$I_{\rm C}$ = 30mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,					
<i>f</i> = 900 MHz					
1dB Compression point	P <sub>-1dB</sub>	-	6	-	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,					
<i>f</i> = 900 MHz					

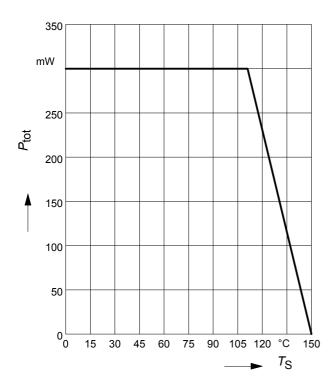
## **Electrical Characteristics** at $T_A = 25$ °C, unless otherwise specified

 ${}^{1}G_{\text{ma}} = |S_{21e} / S_{12e}| (k - (k^{2} - 1)^{1/2})$ 

 $^2$ IP3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 $\Omega$  from 0.2 MHz to 12 GHz



## Total power dissipation $P_{tot} = f(T_S)$

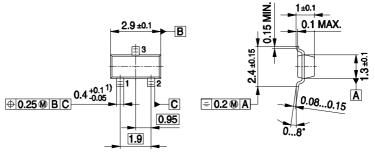




#### BFR93A



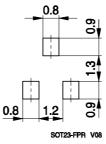




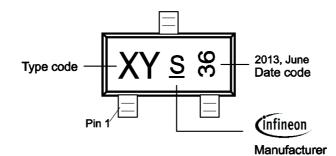
1) Lead width can be 0.6 max. in dambar area

SOT23-PO V08

#### **Foot Print**

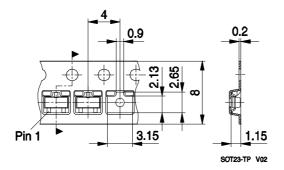


**Marking Layout** 



#### **Standard Packing**

Reel o 180 mm: 3.000 Pieces / Reel Reel o 330 mm = 10.000 Pieces / Reel







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